

6MBI50S-140

IGBT Modules

IGBT MODULE (S series) 1400V / 50A 6 in one-package

■ Features

- Compact Package
- P.C.Board Mount Module
- Low $V_{CE(sat)}$

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

■ Maximum ratings and characteristics

● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Rating	Unit		
Collector-Emitter voltage	V_{CES}	1400	V		
Gate-Emitter voltage	V_{GES}	± 20	V		
Collector current	Continuous	$T_j=25^\circ\text{C}$	I_c	75	A
		$T_j=75^\circ\text{C}$		50	
	1ms	$T_j=25^\circ\text{C}$	I_c pulse	150	A
		$T_j=75^\circ\text{C}$		100	
		- I_c	50	A	
		- I_c pulse	100	A	
Max. power dissipation (1 device)	P_c	360	W		
Operating temperature	T_j	+150	$^\circ\text{C}$		
Storage temperature	T_{stg}	-40 to +125	$^\circ\text{C}$		
Isolation voltage *1	V_{is}	AC 2500 (1min.)	V		
Screw torque	Mounting *2	3.5	N·m		

*1: All terminals should be connected together when isolation test will be done.

*2: Recommendable value : 2.5 to 3.5 N·m (M5)

● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit	
		Min.	Typ.	Max.			
Zero gate voltage collector current	I_{CES}	—	—	1.0	$V_{GE}=0\text{V}$, $V_{CE}=1400\text{V}$	mA	
Gate-Emitter leakage current	I_{GES}	—	—	0.2	$V_{CE}=0\text{V}$, $V_{GE}=\pm 20\text{V}$	μA	
Gate-Emitter threshold voltage	$V_{GE(th)}$	5.5	7.2	8.5	$V_{CE}=20\text{V}$, $I_c=50\text{mA}$	V	
Collector-Emitter saturation voltage	$V_{CE(sat)}$	—	2.4	2.75	$T_j=25^\circ\text{C}$	$V_{GE}=15\text{V}$, $I_c=50\text{A}$	V
		—	3.0	—	$T_j=125^\circ\text{C}$		
Input capacitance	C_{ies}	—	6000	—	$V_{GE}=0\text{V}$	pF	
Output capacitance	C_{oes}	—	1250	—	$V_{CE}=10\text{V}$		
Reverse transfer capacitance	C_{res}	—	1100	—	$f=1\text{MHz}$		
Turn-on time	t_{on}	—	0.35	1.2	$V_{CC}=800\text{V}$	μs	
	t_r	—	0.25	0.6	$I_c=50\text{A}$		
	$t_{r(i)}$	—	0.1	—	$V_{GE}=\pm 15\text{V}$		
Turn-off time	t_{off}	—	0.45	1.0	$R_G=24\Omega$	μs	
	t_f	—	0.08	0.3			
Diode forward on voltage	V_F	—	2.6	3.4	$T_j=25^\circ\text{C}$	$I_F=50\text{A}$, $V_{GE}=0\text{V}$	V
		—	2.2	—	$T_j=125^\circ\text{C}$		
Reverse recovery time	t_{rr}	—	—	0.35	$I_F=50\text{A}$	μs	

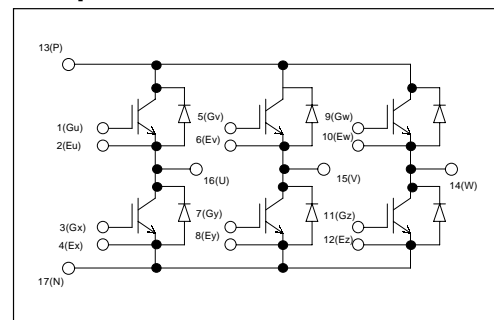
● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	$R_{th(j-c)}$	—	—	0.35	IGBT	$^\circ\text{C/W}$
	$R_{th(j-c)}$	—	—	0.75	FWD	$^\circ\text{C/W}$
	$R_{th(c-f)}^*2$	—	0.05	—	the base to cooling fin	$^\circ\text{C/W}$

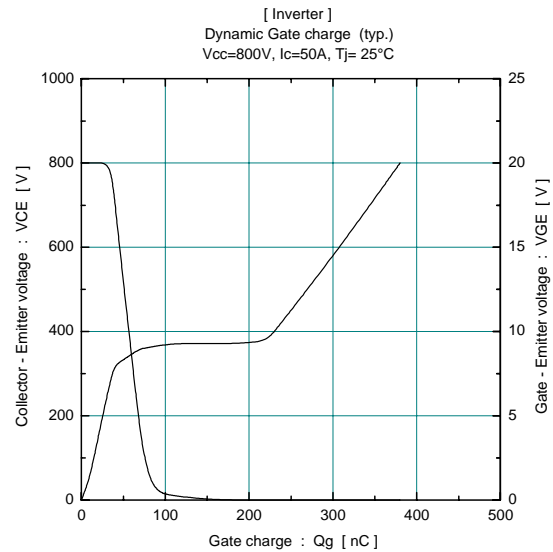
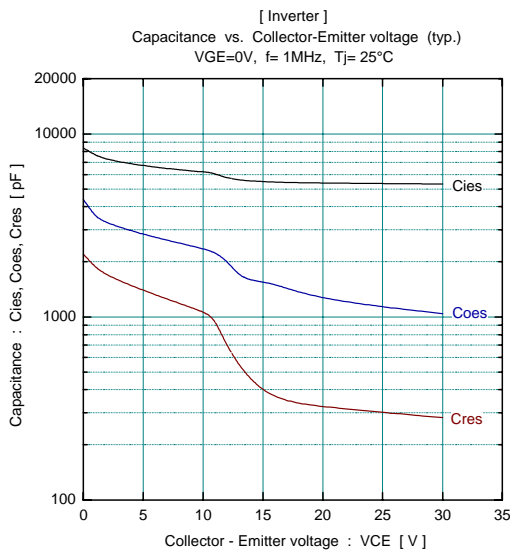
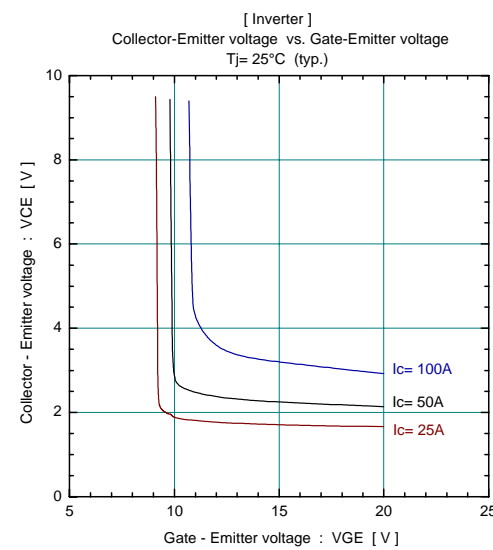
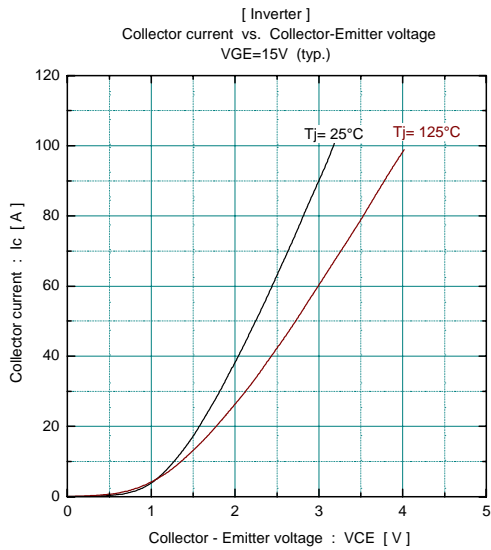
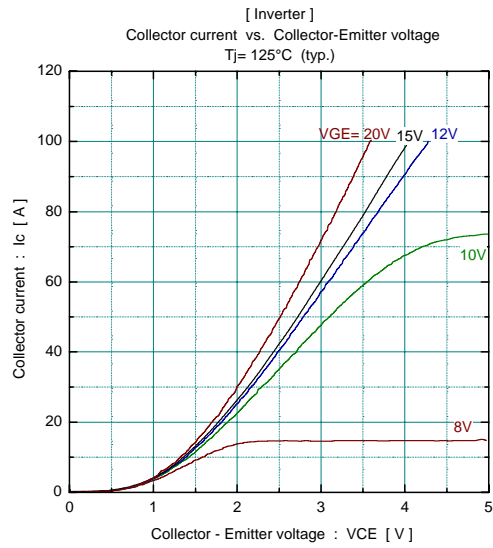
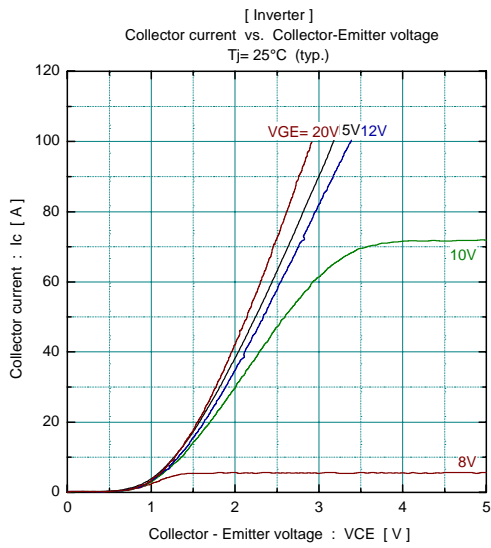
*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound

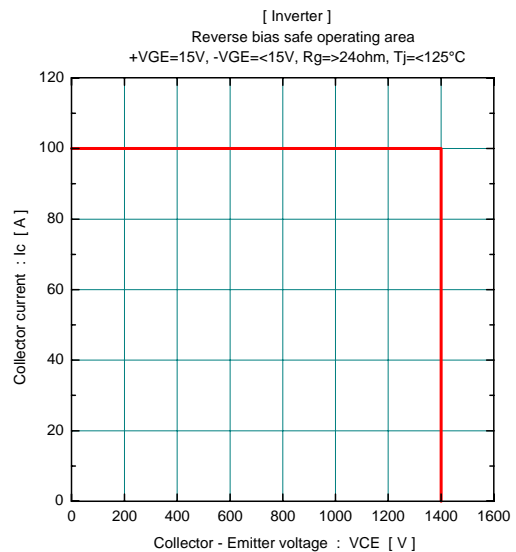
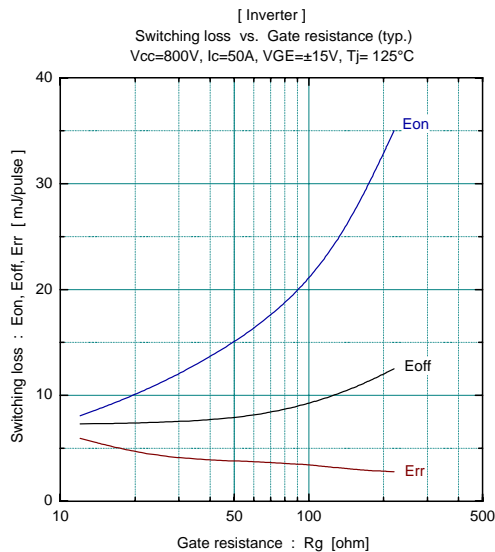
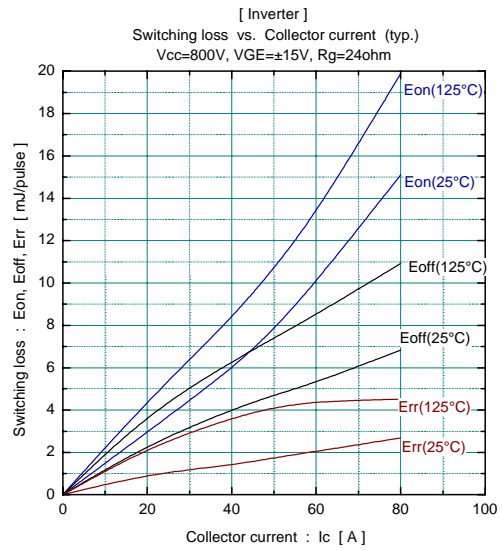
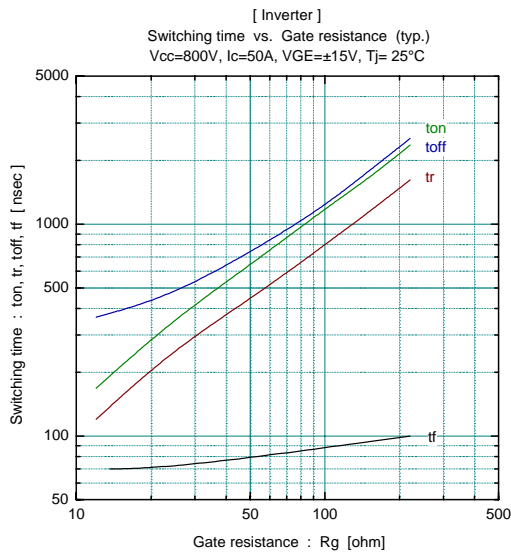
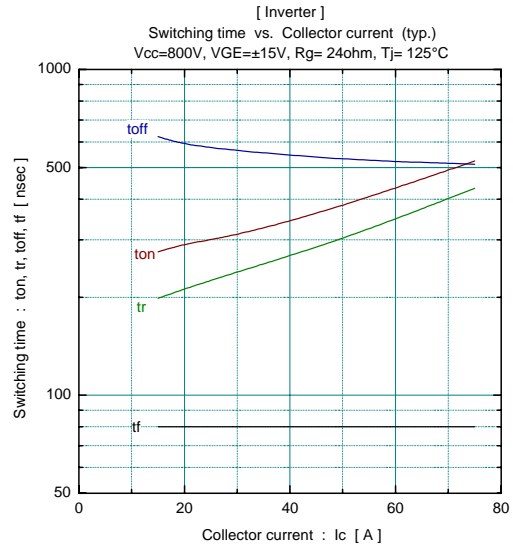
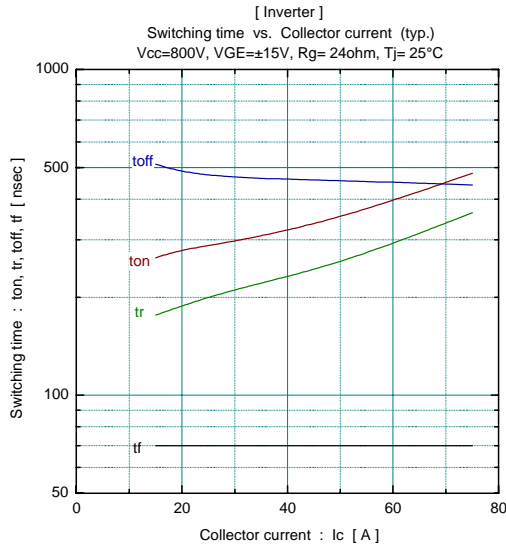


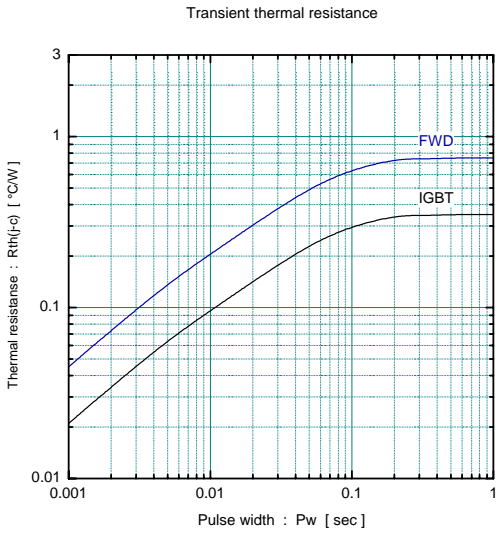
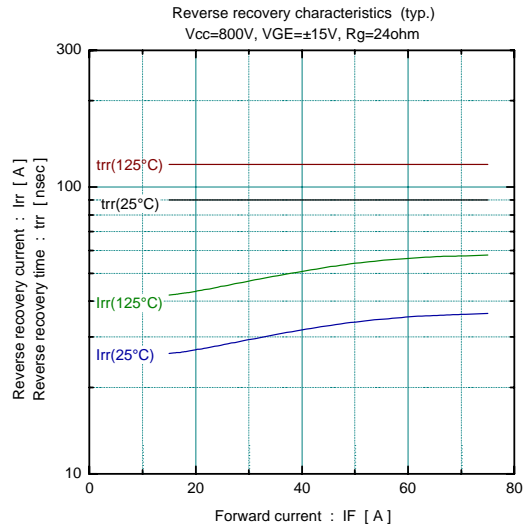
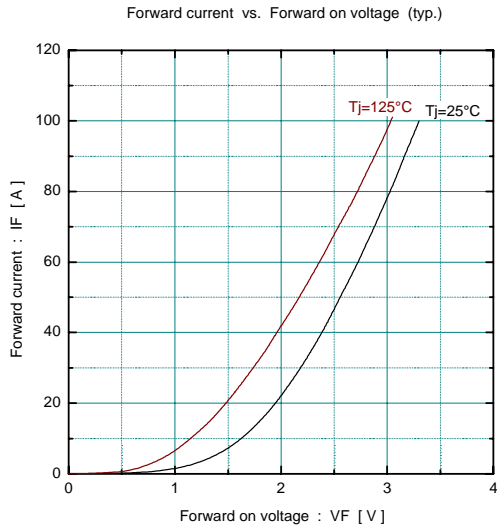
■ Equivalent Circuit Schematic



■ Characteristics







■ Outline Drawings, mm

mass : 180g

